

ATTACHMENT

1. (Original) Structure comprising:
a generally planar workpiece carrier comprising at least one opening for holding a generally disk-shaped workpiece; and
a ring movably placed within said at least one opening, said ring having a discontinuity therein.
2. (Original) Structure of claim 1 wherein said ring is rotatable within said opening.
3. (Original) Structure of claim 1 further comprising a workpiece within said opening and surrounded by said ring, wherein said workpiece can rotate with respect to said carrier.
4. (Original) Structure of claim 3 wherein said carrier is within polishing apparatus, said polishing apparatus comprising one or more pads for polishing said workpiece, said ring having a thickness such that said ring prevents or reduces roll-off in said workpiece.
5. (Original) Structure of claim 1 wherein said workpiece comprises a centrally defined opening therein, said structure further comprising a member inserted into said centrally defined opening.

6. (Currently Amended) ~~Structure~~ A combination of a workpiece and apparatus, wherein said ~~comprising~~ a workpiece having has an opening therein and said apparatus comprises: [[:]]

a generally planar workpiece carrier comprising at least one opening for holding said workpiece;

a member inserted into said opening of said workpiece; and

at least one polishing pad for polishing at least one surface of said workpiece.

7. (Currently Amended) ~~Structure~~ Combination of claim 6 wherein said member prevents or reduces roll-off near the opening ~~within~~ of said workpiece, and wherein said member comprises either a disk or a first ring.

8. (Currently Amended) ~~Structure~~ Combination of claim 6 further comprising a second ring within the opening of said carrier and surrounding said workpiece.

9. (Original) Method comprising:

providing a structure comprising a generally planar workpiece carrier comprising at least one opening:

providing a ring within said at least one opening, said ring having a discontinuity therein;

placing a generally disk-shaped workpiece within said ring; and

polishing said workpiece by applying at least one polishing pad surface against said workpiece.

10. (Original) Method of claim 9 wherein said workpiece can rotate during polishing.
11. (Original) Method of claim 9 wherein said ring prevents or reduces roll-off in said workpiece during polishing.
12. (Original) Method of claim 9 wherein said polishing comprises applying two generally planar polishing pads against upper and lower surfaces of said workpiece, and applying a polishing slurry between said pads and said workpiece during polishing.
13. (Original) Method of claim 9 wherein said workpiece comprises a centrally defined opening therein, said structure further comprising a member inserted into said centrally defined opening.
14. (Currently Amended) Method comprising:
 - providing a structure comprising a generally planar workpiece carrier comprising at least one opening:
 - placing a generally disk-shaped workpiece within said opening of said carrier, said workpiece having an opening therein;
 - providing a member within said opening of said workpiece; and
 - polishing said workpiece by applying at least one polishing pad surface against said workpiece, wherein said workpiece carrier, member and polishing pad act as at least a portion of polishing apparatus.

15. (Original) Method of claim 14 wherein said member prevents or reduces roll-off of said workpiece, said member comprising either a ring or a disk within the opening of said workpiece.

16. (Original) Method of claim 14 further comprising providing a ring between said workpiece and said carrier, said ring preventing or reducing roll-off in said workpiece during polishing.